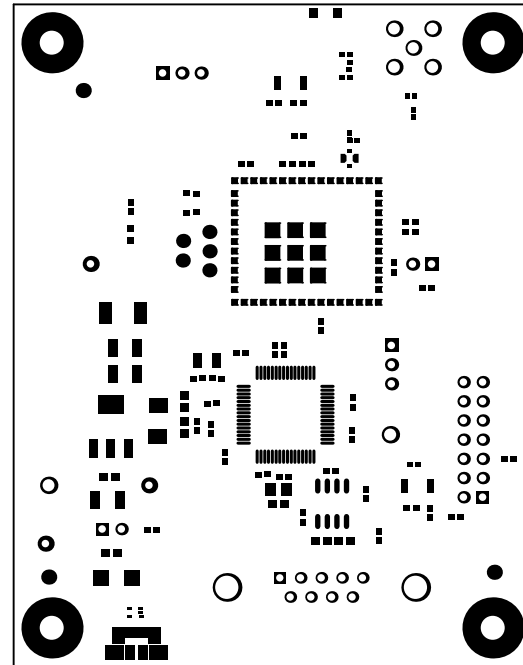
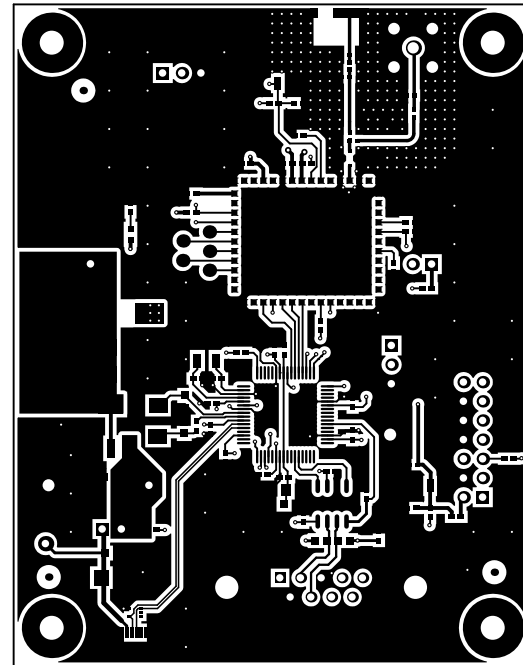


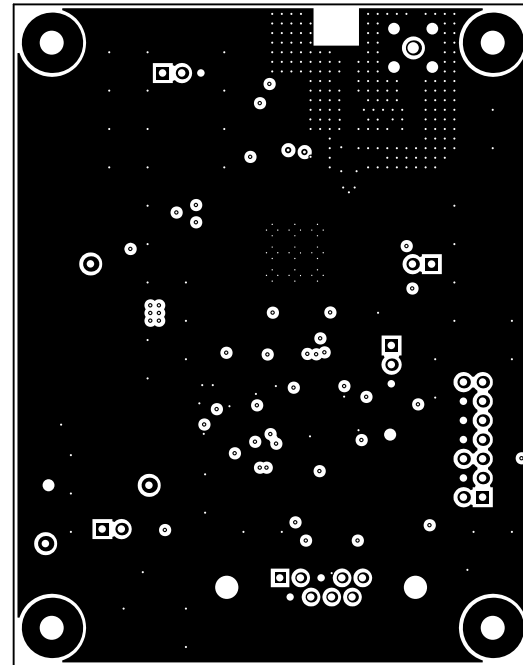
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00380		
PLOT NAME = Top Overlay	GENERATED : 9/22/2015 10:26:16 AM	TEXAS INSTRUMENTS	



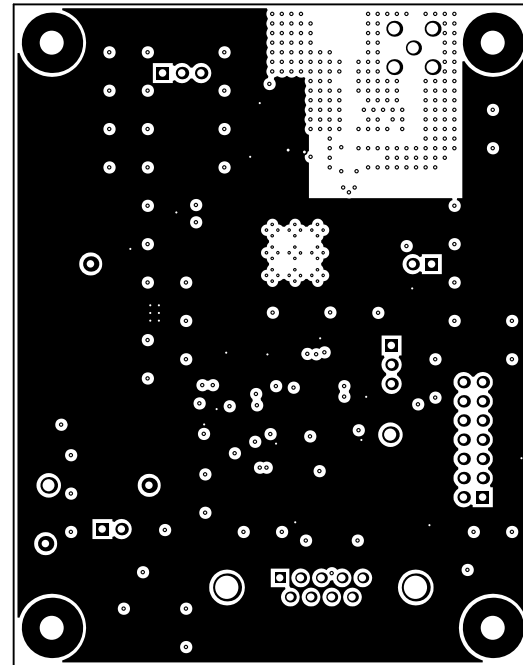
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00380		
PLOT NAME = Top Solder Mask	GENERATED : 9/22/2015 10:26:17 AM	TEXAS INSTRUMENTS	



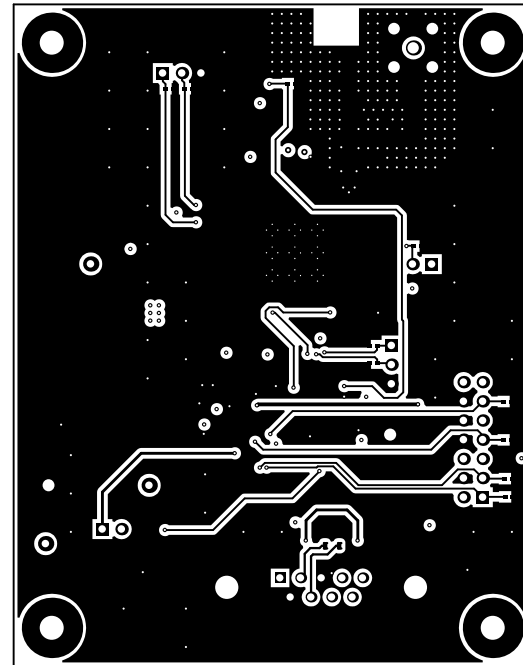
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00380		
PLOT NAME = Top Layer	GENERATED : 9/22/2015 10:26:19 AM	TEXAS INSTRUMENTS	



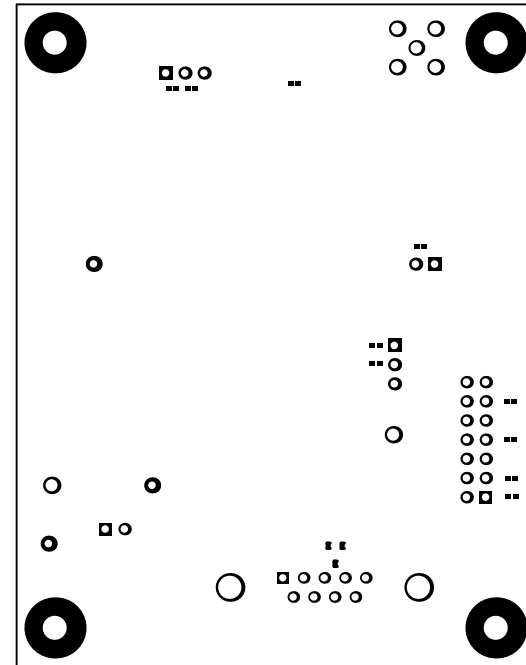
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00380		
PLOT NAME = Signal Layer 1	GENERATED : 9/22/2015 10:26:20 AM	TEXAS INSTRUMENTS	



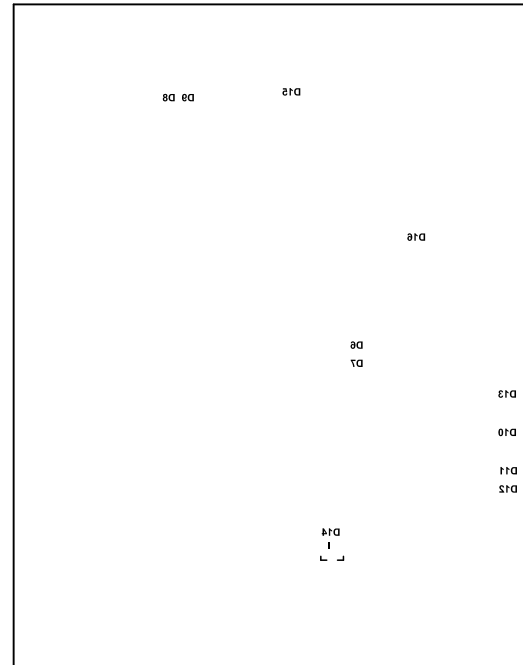
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00380		
PLOT NAME = Signal Layer 2	GENERATED : 9/22/2015 10:26:22 AM	TEXAS INSTRUMENTS	



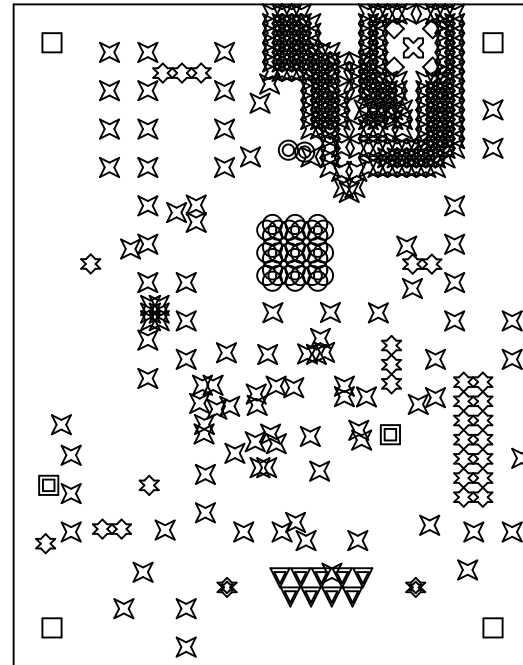
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00380		
PLOT NAME = Bottom Layer	GENERATED : 9/22/2015 10:26:24 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00380		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/22/2015 10:26:26 AM	TEXAS INSTRUMENTS	

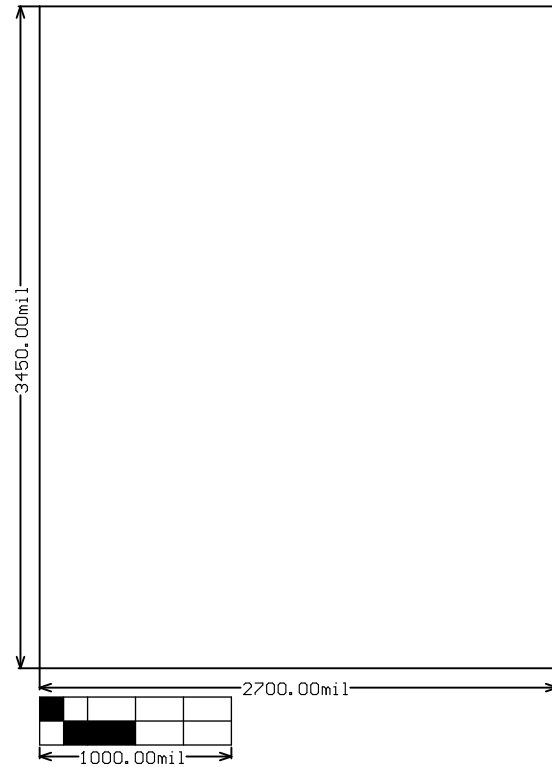


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00380		
PLOT NAME = Bottom Overlay	GENERATED : 9/22/2015 10:26:28 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	36	7.87mil (0.200mm)	PTH	Round
✕	294	12.00mil (0.305mm)	PTH	Round
●	2	16.00mil (0.406mm)	PTH	Round
▼	9	39.37mil (1.000mm)	PTH	Round
☆	27	40.00mil (1.016mm)	PTH	Round
⊗	1	59.06mil (1.500mm)	PTH	Round
◇	4	62.99mil (1.600mm)	PTH	Round
■	2	63.00mil (1.600mm)	PTH	Round
✳	2	122.05mil (3.100mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
	381 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00380		
PLOT NAME = Drill Drawing	GENERATED : 9/22/2015	10:26:30 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4040	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00380		
PLOT NAME = Board Dimensions	GENERATED : 9/22/2015 10:26:32 AM	TEXAS INSTRUMENTS	

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